Low-Solids, High-Reliability, Pin-Testable, Lead-Free/SnPb Wave Flux

DESCRIPTION

ALPHA EF-6103 is an alcohol based flux designed to optimize solderability and reliability. It is formulated for both standard and thicker, high-density PCBs in both Lead-free (standard SAC and Low Ag SAC alloys) and eutectic SnPb processes. It is designed to have low bridging on bottom side QFPs, as well as provide superior performance in pin testing, hole-fill and solderballing. Additionally, it provides good Lead-free solder joint cosmetics with an evenly spread, tack free residue.

FEATURES & BENEFITS

Features for Lead-free:

- Pin testable
- Excellent post-soldering cosmetics on PCB
- Good hole fill in both dual and single wave soldering
- Low bridging performance on connectors, 0.65 mm and 0.80 mm QFPs.

Benefits:

- Evenly spread, tack free residue.
- Excellent Lead-free soldering performance on various board finishes.
- Can be used in Lead-free or SnPb processes
- Halide free

APPLICATION

PREPARATION: In order to maintain consistent soldering performance and electrical reliability, it is important to begin the process with circuit boards and components that meet established requirements for solderability and ionic cleanliness. It is suggested that assemblers establish specifications on these items with their suppliers and that suppliers provide Certificates of Analysis with shipments and/or assemblers perform incoming inspection. A common specification for the ionic cleanliness of incoming boards and components is $5\mu g/in^2$ maximum, as measured by an ionic contamination tester.

Care should be taken in handling the circuit boards throughout the process. Boards should always be held at the edges. The use of clean, lint-free gloves is also recommended.

Conveyors, fingers and pallets should be cleaned. **ALPHA AutoClean 40** cleaner is recommended for this process.

FLUX APPLICATION: ALPHA EF-6103 can be applied by spray or foam. When spray fluxing, the uniformity of the coating can be visually checked by running a piece of cardboard over the spray fluxer or by processing a board-sized piece of tempered glass through the spray and then through the preheat section.

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SAFETY

Consult the SDS for all safety information. The most recent version of the SDS is available from alphaassembly.com.

Inhalation of the volatilized flux activator fumes, which are generated at soldering temperatures, may cause headaches, dizziness and nausea.

Suitable fume extraction equipment should be used to remove the flux from the work area. An exhaust at the exit end of the wave solder machine may also be needed to completely capture the fumes. Observe precautions during handling and use. Suitable protective clothing should be worn to prevent the material from coming in contact with skin and eyes.

GENERAL GUIDELINES FOR MACHINE SETTINGS

| OPERATING PARAMETER | SAC305 or Low Ag SAC alloys | 63/37 Sn/Pb |
|--|--|---|
| Amount of Flux Applied | Spray: 800 to $1200\mu g/in^2$ of solids/in ² for dual wave and 700 to $1000 \mu g/in^2$ of solids/in ² for single wave soldering | Spray: 800 to 1200µg/in ² of solids/in ² for dual wave and 600 to 900µg/in ² of solids/in ² for single wave soldering |
| Top-Side Preheat Temperature | 95 -125°C | 80 -110°C |
| Bottom side Preheat Temp. | 0 to +40°F (0 to +22°C) vs. Top-Side | 0 to +40°F (0 to +22°C) vs. Top-Side |
| Recommended Preheat Profile | Straight ramp to desired top-side temp. | Straight ramp to desired top-side temp. |
| Maximum Ramp Rate of Topside Temperature (to avoid component damage) | 2°C/second (3.5°F/second) maximum | 2°C/second (3.5°F/second) maximum |
| Conveyor Angle | 5 - 8° (6° most common recommended by equipment manufacturers) | 5-8° (6° most common recommended by equipment manufacturers) |
| Conveyor Speed | 1.0 – 2.0 meters/min (3.3 – 6.6 ft/min) EF-6103 is capable of running at a slower conveyor speed for certain types of Lead-free wave soldering process | 1.0–2.0 meters/minute |
| Contact Time in the Solder (includes Chip Wave & Primary Wave) | 2 – 7 seconds (3 - 5 seconds most common) | 1.5 - 4.0 seconds (2 ¹ ⁄ ₂ - 3 seconds most common) |
| Solder Pot Temperature: | 255-265°C | 240-250°C |

These are general guidelines which have proven to yield excellent results; however, depending upon your equipment, components, and circuit boards, your optimal settings may be different. In order to optimize your process, it is recommended to perform a design experiment, optimizing the most important variables (amount of flux applied, conveyor speed, topside preheat temperature, solder pot temperature and board orientation).

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FLUX SOLIDS CONTROL: If rotary drum spray fluxing, the flux solids will need to be controlled via thinner addition.For measuring the solids content, Alpha's Flux Solids Control Kit #3, a digital titrator, is suggested. Request Alpha's Technical Bulletin SM-458 for details on the kit and titration procedure. When operating a rotary drum fluxer continuously, the acid number should be checked every eight hours. Over time, debris and contaminants will accumulate in recirculating type flux applicators. For consistent soldering performance, dispose of spent flux every 40 hours of operation. After emptying the flux, the reservoir should be thoroughly cleaned with IPA.

RESIDUE REMOVAL: ALPHA EF-6103 is a no-clean flux and the residues are designed to be left on the board. If desired, flux residues can be removed with **ALPHA 2110** saponifier cleaner and with other commercially available solvent cleaners and saponifier cleaners.

TECHNICAL DATA

| Item | Specification | Item | Specification |
|-----------------------------------|---------------------------|-----------------------------|---------------|
| Appearance | Clear, Light Amber Liquid | pH, 5% v/v aqueous solution | 3.3 |
| Solids Content, wt/wt | 3.6% | Recommended Thinner | ALPHA 425 |
| Specific Gravity @ 25°C (77°C) | 0.796 ± 0.004 | Shelf Life | 360 days |
| Acid Number (mg KOH/g) | 22.4 ± 1.3 | IPC J-STD-004A Designation | ORL0 |
| Flash Point (T.C.C.) | 17°C | | |

CORROSION & ELECTRICAL TESTING – SAC305 ALLOY

CORROSION TESTING

| Test | Requirement for ORL0 | Results |
|--|-------------------------------|--------------------------|
| Silver Chromate Paper IPC-TM 650 Test Method 2.3.33 | No detection of halide | PASS |
| Copper Mirror Tests IPC-TM 650 Test Method 2.6.32 | No complete removal of copper | PASS |
| Copper Corrosion Test IPC-TM 650 Test Method 23.15 | No evidence of corrosion | No Evidence of Corrosion |

IPC J-STD-004A SURFACE INSULATION RESISTANCE

| Test | Conditions | Requirements | Results | |
|--|---------------------|---------------------------------|--------------------------|--|
| "Comb-Down" Un-cleaned | 85°C/85% RH, 7 days | 1.0 x 10 ⁸ Ω minimum | 6.6 x 10 ⁹ Ω | |
| "Comb-Up" Un-cleaned | 85°C/85% RH, 7 days | 1.0 x 10 ⁸ Ω minimum | 2.1 x 10 ¹⁰ Ω | |
| Control Boards 85°C/85% RH, 7 days $1.0 \times 10^9 \Omega$ minimum $3.6 \times 10^{10} \Omega$ | | | | |
| IPC Test Condition (per J-STD-004A): -50V, measurement @ 100V/IPC B-24 board (0.4 mm lines, 0.5 mm spacing). | | | | |

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IPC J-STD-004B SURFACE INSULATION RESISTANCE

| Test | Requirements | Results (min. of all measurements recorded) | | |
|---|---|---|-------------------------|--------|
| Test | (<1.0 x 10 ⁸ allowed during initial 24 hrs.) | < 24 Hrs | 24 – 168 Hrs | Visual |
| "Comb-Down" Un-cleaned | 1.0 x 10 ⁸ Ω minimum | 1.6 x 10 ⁸ Ω | 8.6 x 10 ⁸ Ω | PASS |
| "Comb-Up" Un-cleaned | 1.0 x 10 ⁸ Ω minimum | 5.3 x 10 ⁸ Ω | 9.5 x 10 ⁹ Ω | PASS |
| Control Boards | 1.0 x 10 ⁹ Ω minimum | 2.7 x 10 ⁹ Ω | 9.4 x 10 ⁹ Ω | NA |
| IPC Test Condition (per J-STD-004B TM2.6.3.7): IPC B-24 coupons, 12V, 40°C, 90% RH, measurements recorded @ 20min intervals | | | | |

JIS STANDARD SURFACE INSULATION RESISTANCE

| Test | Conditions | Requirements | Controls | Results |
|--|---------------|--|--------------------------|--------------------------|
| Initial | Ambient | $1.0 \times 10^{11} \Omega$ minimum | 1.2 x 10 ¹² Ω | 3.5 x 10 ¹¹ Ω |
| After 7 days | 40°C / 90% RH | $1.0 \text{ x} 10^{10} \Omega$ minimum | 3.5 x 10 ¹¹ Ω | 3.9 x 10 ¹⁰ Ω |
| Recovered 25°C/75% RH, 7 days 1.0 x 10 ¹¹ Ω minimum 2.2 x 10 ¹¹ Ω 1.4 x 10 ¹¹ Ω | | | | |
| All Measurements @ 100V, JIS Boards (0.32mm lines, 0.32 mm spacing, same as IPC B25 Boards). | | | | |

BELLCORE SURFACE INSULATION RESISTANCE

| Test | Conditions | Requirements | Results |
|---|---------------------|-------------------------------------|--------------------------|
| "Comb-Down" Un-cleaned | 35°C/85% RH, 4 days | $1.0 \times 10^{11} \Omega$ minimum | 1.7 x 10 ¹¹ Ω |
| "Comb-Up" Un-cleaned | 35°C/85% RH, 4 days | $1.0 \times 10^{11} \Omega$ minimum | 2.1 x 10 ¹¹ Ω |
| Control Boards | 35°C/85% RH, 4 days | $2.0 \times 10^{11} \Omega$ minimum | 2.4 x 10 ¹¹ Ω |
| Bellcore Test Condition (per GR 78-CORE, Issue 1: 48 Volts, measurement @ 100V/25 mil lines/50 mil spacing. | | | |

BELLCORE ELECTROMIGRATION

| Test | SIR (Initial) | SIR (Final) | Requirements | Results | Visual Results |
|--|--------------------------|--------------------------|------------------------------------|----------------|----------------|
| "Comb-Up" Un-cleaned | 5.5 x 10 ¹⁰ Ω | 2.9 x 10 ¹¹ Ω | SIR (Initial) / SIR (Final) <10 | Pass | Pass |
| "Comb-Down" Uncleaned | 5.9 x 10 ⁹ Ω | 2.4 x 10 ¹⁰ Ω | SIR (Initial) / SIR (Final) <10 | Pass | Pass |
| Control | 2.8 x 10 ¹¹ Ω | 7.0 x 10 ¹¹ Ω | Not applicable | Not applicable | Not applicable |
| Bellcore Test Condition (per GR 78-CORE, Issue 1): 65°C/85% RH/500 Hours/10V, measurement @ 100V/IPC B-25B Pattern (12.5 mil lines, 12.5 mil spacing). | | | | | |



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CONTACT INFORMATION

To confirm this is the most recent issue, please contact Alpha Assembly Solutions

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency directory assistance Chemtrec 1 - 800 - 424 - 9300.

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